

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain to Source Voltage		150	V	
V _{GS}	Gate to Source Voltage		±20	V	
-	Drain Current - Continuous (V _{GS} =10) (Note 1)	$T_C = 25^{\circ}C$	110	Α	
D	Pulsed Drain Current	rent $T_C = 25^{\circ}C$ See Fi		A	
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	502	mJ	
P _D	Power Dissipation		333	W	
	Derate above 25°C		2.22	W/ ^o C	
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance Junction to Case		0.45	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance Junction to Ambient (Note 3)		43	°C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB075N15A	FDB075N15A_F085	D2-PAK(TO-263)	330mm	24mm	800 units

Notes:

1: Current is limited by bondwire configuration. 2: Starting $T_J = 25^{\circ}$ C, L = 0.24mH, I_{AS} = 64A, V_{DD} = 100V during inductor charging and V_{DD} = 0V during time in avalanche 3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Cha	racteristics					
B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V		-	-	V
	Drain to Source Leakage Current	V_{DS} =150V, T_{J} = 25°C	-	-	1	μA
DSS	Dialitito Source Leakage Current	$V_{GS} = 0V$ $T_J = 175^{\circ}C(Note 4)$) -	-	1	mA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$	-	-	±100	nA
DS(on)	Drain to Source On Resistance	$I_D = 80A, T_J = 25^{\circ}C$	-	5.5	7.5	mΩ
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.0	3.0	4.0	V
DS(on)	Drain to Source On Resistance		-		-	
D3(0II)		V_{GS} = 10V T_{J} = 175°C(Note 4)		14.2	20	mΩ
C _{iss}	c Characteristics	V _{DS} = 75V, V _{GS} = 0V,		5595	-	pF
C _{oss}	Output Capacitance	= f = 1MHz	-	513	-	pF
	Reverse Transfer Capacitance		-	16	-	pF
C _{rss}		£ 4 NALL_	-	2.4	-	Ω
	Gate Resistance	f = 1MHz				
R _g	Gate Resistance Total Gate Charge at 10V	$V_{GS} = 0 \text{ to } 10V$ $V_{DD} = 75V$	-	80	95	nC
R _g Q _{g(ToT)}			-	80 11	95 13	nC nC
$\frac{C_{rss}}{R_g}$ $\frac{Q_{g(ToT)}}{Q_{g(th)}}$ Q_{gs}	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V $V_{DD} = 75V$	-			-

FDB075N15A_F085 N-Channel Power Trench[®] MOSFET

Switching Characteristics

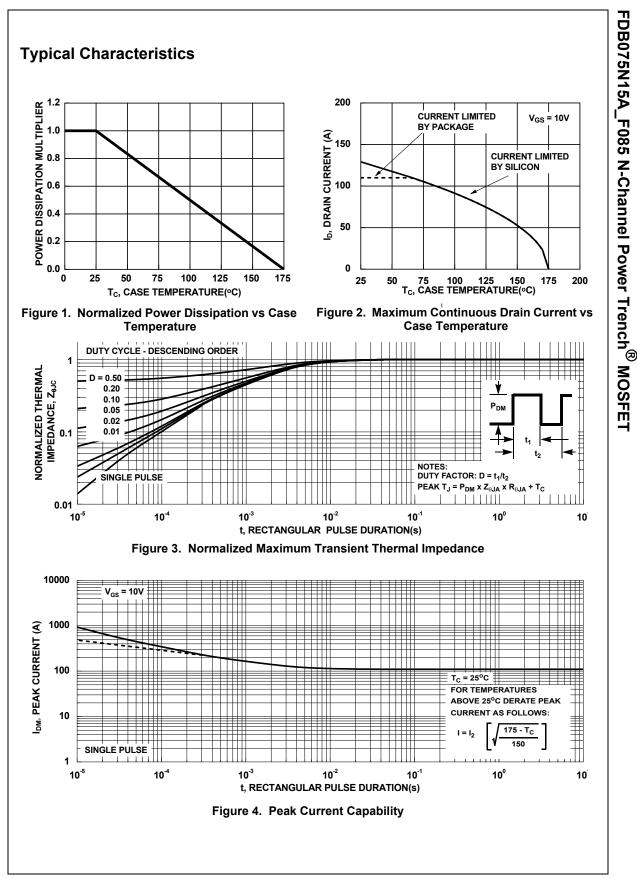
t _{on}	Turn-On Time		-	-	100	ns
t _{d(on)}	Turn-On Delay Time		-	33	-	ns
t _r	Rise Time	V _{DD} = 75V, I _D = 80A,	-	46	-	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10V, R_{GEN} = 6 Ω	-	76	-	ns
t _f	Fall Time		-	25	-	ns
t _{off}	Turn-Off Time		-	-	138	ns

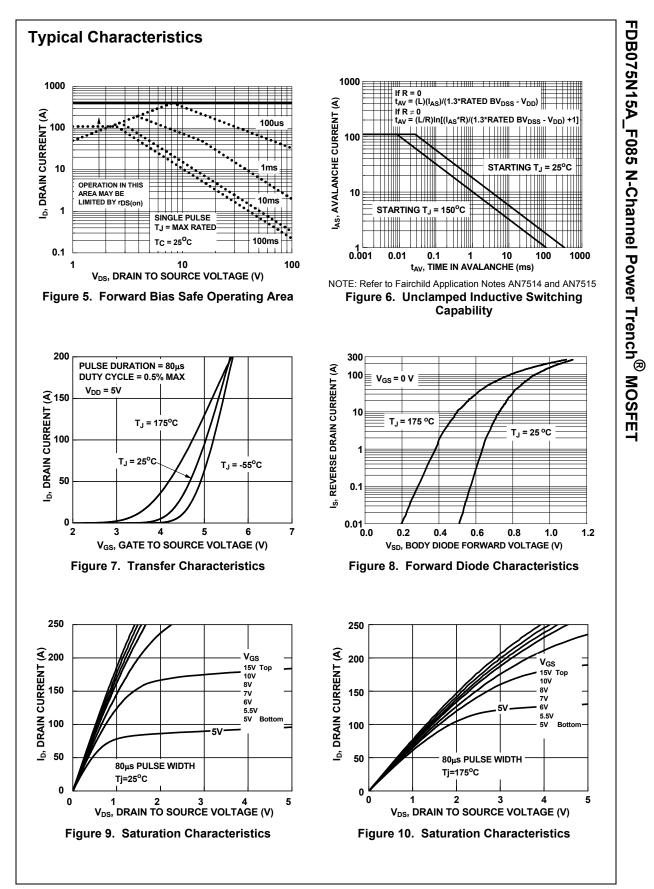
Drain-Source Diode Characteristics

V _{SD}	Source to Drain Diode Voltage	I _{SD} = 80A, V _{GS} = 0V	-	-	1.25	V
	Source to Drain Diode Voltage	I _{SD} = 40A, V _{GS} = 0V	-	1.	1.2	V
T _{rr}	Reverse Recovery Time	I _F = 80A, dI _{SD} /dt = 100A/μs,	-	118	132	ns
Q _{rr}	Reverse Recovery Charge	V _{DD} =120V	-	341	494	nC

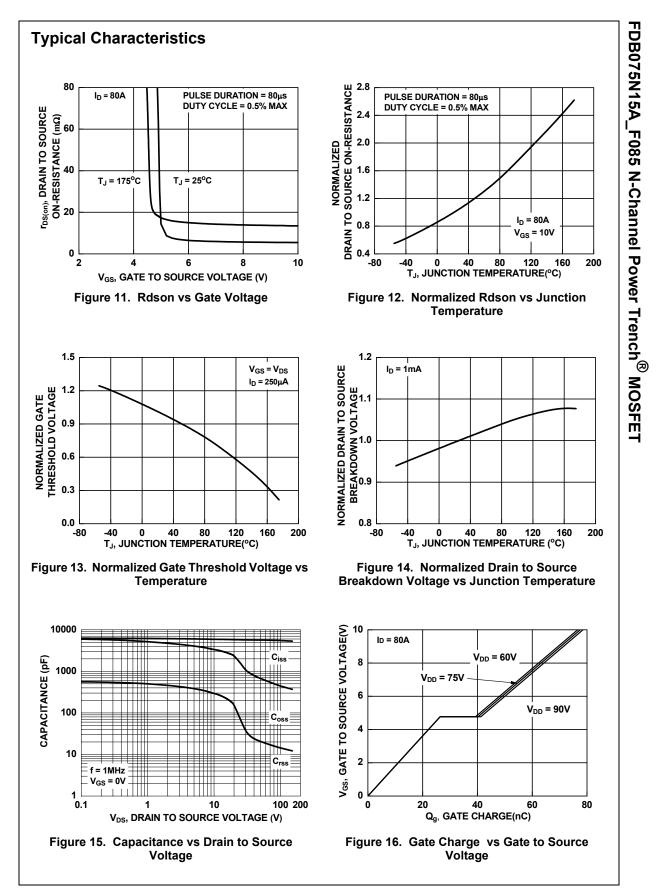
Notes:

4: The maximum value is specified by design at T_J = 175°C. Product is not tested to this condition in production.





FDB075N15A_F085 Rev. C3



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